1.0 SCOPE

This specification covers performance, tests and quality requirements for 1.25 mm pitch Wire to Board DIP & SMT Type of 10114826~10114831 Series.

2.0 REFERENCE DOCUMENTS

EIA-364 ELECTRONICS INDUSTRIES ASSOCIATION

3.0 DEFINITIONS

3.1 Design and Construction

Product shall be of design, construction and physical dimensions specified on applicable product drawing. All materials conform to RoHS

- 3.2 Materials and Finish
 - 3.2.1 Contact: Copper alloy
 - Finish: (a) Contact Area: Based on drawing specification.
 - (b) Under plate: Nickel-plated all over.
 - (c) Solder area: Based on drawing specification.
 - 3.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0 and meet IEC 60695-2 glowing/hot wire test.
 - 3.2.3 M.H.D: Copper Alloy, Plating based on drawing specification.
- 3.3 Ratings
 - 3.3.1 Voltage: 125 Volts AC (per pin)
 - 3.3.2 Current: 1 Amp (0.8 A -- 32 AWG)

4.0 **REQUIREMENTS**

4.1 Test Requirements and Procedures Summary

| Item | Requirement | Standard | | | | | |
|--|--|---|--|--|--|--|--|
| Examination of Product | Product shall meet requirements of applicable product drawing and specification. | Visual, dimensional and functional per applicable quality inspection plan. | | | | | |
| | ELECTRICAL | | | | | | |
| Item | Requirement | Standard | | | | | |
| Low-signal Level Contact Resistance | 20 m Ω Max.(initial)per contact 40 m Ω Max. after test | Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23) | | | | | |

GS-12-675

TITLE

UMBER

1.25 mm pitch SR WTB Connector

TYPE



Insulation ResistanceUnmated connectors, apply
500 V DC between adjacent terminals.
(EIA-364-21)Dielectric
Withstanding Voltage500 VAC Min. at sea level
for 1 minute.
No discharge, flashover or
breakdown.
Current leakage: 1 mA max.Test between adjacent contacts of
unmated connectors.
(EIA-364-20)

| MECHANICAL | | | | | |
|---------------------------------------|----------------|---|--|--|--|
| Item | Requirement | Standard | | | |
| Durability | 30 cycles. | The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min. (EIA-364-09) | | | |
| Insertion/Withdrawal Force | See Section 7. | Operation Speed : 25.4 ± 3 mm/minute Measure the force required to mate/Unmate connector. (EIA-364-13) | | | |
| Contact Retention Force | 0.5kgf MIN. | Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the housing. | | | |
| Hold down /Housing Retention Force | 1.0kgf MIN. | Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the hold down assembled in the housing. | | | |
| Wire Retention Force | 0.5kgf MIN. | Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the housing. | | | |
| Terminal / Housing Retention Force | 0.5kgf MIN. | Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the terminal assembled in the housing. | | | |

| UMBER | GS-12-675 | PRODUCT SPECIFICATION | | FC |
|-------|---------------|-----------------------|----------------------------|-----------------|
| TITLE | 1.25 mm pitcl | n SR WTB Connector | PAGE 3 of 7 | REVISION B |
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| Vibration | 1 μs Max. | The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I) |
|-----------|-----------|---|
|-----------|-----------|---|

| Shock (Mechanical) | 1 μs Max. | Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A) |
|--------------------|-----------|--|
| | | (EIA-364-27, test condition A) |

| ENVIRONMENTAL | | | | | | |
|----------------------|-------------------------------|--|--|--|--|--|
| Item | Requirement | Standard | | | | |
| Resistance to Reflow | See Product Qualification and | Pre Heat [∶] 150°C ~180°C , 60~90sec. | | | | |
| Soldering Heat | Test Sequence Group 9 (Lead | Heat:230℃ Min., 40sec Min. | | | | |
| | Free) | Peak Temp.:260℃Max, 10sec Max. | | | | |
| Resistance to Hand | Excessive pressure shall not | Soldering iron ∶ 350±10℃ | | | | |
| Soldering Heat | be applied to the terminals. | Duration : 3~4 sec. at least | | | | |
| | Test Sequence Group 10 | | | | | |
| | | Mate module and subject to follow | | | | |
| | | condition for 5 cycles. | | | | |
| Thormal Shook | See Product Qualification and | 1 cycles: | | | | |
| Thermai Shock | Test Sequence Group 3 | -40 +0/-3 °C, 30 minutes | | | | |
| | | +85 +3/-0 °C, 30 minutes | | | | |
| | | (EIA-364-32, test condition A) | | | | |
| | See Breduct Qualification and | Mated Connector | | | | |
| Humidity | Test Sequence Group 2 | 40℃, 90~95% RH, 96 hours | | | | |
| | Test Sequence Group 3 | (EIA-364-31, test condition A) | | | | |

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| Temperature life | See Product Qualification and Test Sequence Group 4 | Subject mated connectors to temperature life at 105°Cfor 96 hours. Measure Signal. (EIA-364-17, Test condition A) |
|------------------|---|---|
| Salt Spray | See Product Qualification and Test Sequence Group 5 | Subject mated/unmated connectors to 5% salt-solution concentration, 35°Cfor 48 hours. (EIA-364-26, Test condition B) |
| Solder ability | Solder able area shall have minimum of 95% solder coverage. | And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. |

Note. Flowing Mixed Gas shell be conduct by customer request.

5.0 INFRARED REFLOW CONDITION

5.1 Lead-Free Process



UMBER

TITLE

1.25 mm pitch SR WTB Connector

TYPE

6.0 PRODUCT QUALIFICATION AND TEST SEQUENCES

| | Test Group | | | | | | | | | |
|---|---------------|-----|-------|-----|-----|---|---|---|---|----|
| Test or Examination | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 |
| | Test Sequence | | | | | | | | | |
| Examination of Product | | | 1、7 | 1、6 | 1、4 | | | | 1 | 1 |
| Low-signal Level Contact Resistance | 1、5 | 1、4 | 2、10 | 2、9 | 2、5 | | | | 3 | |
| Insulation Resistance | | | 3、9 | 3、8 | | | | | | |
| Dielectric Withstanding Voltage | | | 4 • 8 | 4、7 | | | | | | |
| Insertion / Withdrawal Force | 2、4 | | | | | | | | | |
| Durability | 3 | | | | | | | | | |
| Contact Retention Force (Wafer) | | | | | | | 1 | | | |
| Vibration(Random) / Vibration | | 2 | | | | | | | | |
| Shock (Mechanical) | | 3 | | | | | | | | |
| Thermal Shock | | | 5 | | | | | | | |
| Humidity | | | 6 | | | | | | | |
| Temperature life | | | | 5 | | | | | | |
| Salt Spray | | | | | 3 | | | | | |
| Solder ability | | | | | | 1 | | | | |
| Wire Retention Force | | | | | | | | 1 | | |
| Terminal / Housing Retention Force | | | | | | | | 2 | | |
| Metal Hold-Down /Housing Retention Force | | | | | | | 2 | | | |
| Resistance to Reflow Soldering Heat | | | | | | | | | 2 | |
| Resistance to Hand Soldering Heat | | | | | | | | | | 2 |
| Sample Size | 4 | 4 | 4 | 4 | 4 | 2 | 4 | 4 | 4 | 4 |

UMBER

TITLE

1.25 mm pitch SR WTB Connector

TYPE



7.0 INSERTION / WITHDRAWAL FORCE

| No of | Insertion Force (Kgf, Max) | | | Withdr | awal Force (Kg | f, Min) |
|-------|------------------------------|------|------|--------|----------------|---------|
| СКТ | 1st | 6th | 30th | 1st | 6th | 30th |
| 2 | 2.00 | 1.80 | 1.60 | 0.28 | 0.23 | 0.18 |
| 3 | 2.50 | 2.30 | 2.10 | 0.30 | 0.25 | 0.20 |
| 4 | 3.00 | 2.80 | 2.60 | 0.33 | 0.28 | 0.23 |
| 5 | 3.50 | 3.30 | 3.10 | 0.38 | 0.33 | 0.28 |
| 6 | 4.00 | 3.80 | 3.60 | 0.43 | 0.38 | 0.33 |
| 7 | 4.50 | 4.30 | 4.10 | 0.48 | 0.43 | 0.38 |
| 8 | 5.00 | 4.80 | 4.60 | 0.53 | 0.48 | 0.43 |
| 9 | 5.50 | 5.30 | 5.10 | 0.56 | 0.51 | 0.46 |
| 10 | 6.00 | 5.80 | 5.60 | 0.59 | 0.54 | 0.49 |
| 11 | 6.50 | 6.30 | 6.10 | 0.62 | 0.57 | 0.52 |
| 12 | 7.00 | 6.80 | 6.60 | 0.65 | 0.60 | 0.55 |
| 13 | 7.50 | 7.30 | 7.10 | 0.68 | 0.63 | 0.58 |
| 14 | 8.00 | 7.80 | 7.60 | 0.71 | 0.66 | 0.61 |
| 15 | 8.50 | 8.30 | 8.10 | 0.74 | 0.69 | 0.64 |

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RECORD RETENTION

| Revision | Page | Description | ECR No. | Date |
|----------|------|------------------|-------------|------------|
| Α | ALL | New release | T10-0090 | 11/09/2010 |
| В | ALL | Change the title | ELX-N-55722 | 07/05/2025 |
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